© Copyright 2005. IPC, B	© Convright 2005 IPC Bannockburn Illinois All rights reserved under both				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
	21.1 IPC Web Site for Information on IPC-1752 Standard Form T http://www.ipc.org/IPC-175x Distribution				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information					on			
Supplier Information													
Company name* Company unique ID				Unique ID A			D Authority			Response Date*			
nsemi									2024-05-20				
Contact Name	ame Title - Contact				Phone - Contact*				Email - Contact*				
Product-Env-Stewards	roduct-Env-Stewards Product Enviro Compliance				NA			Produ	Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Representative					Phone - Representative*			Email	Email - Representative*				
Product-Env-Stewards Product Enviro C			ro Compliance		NA			Produ	Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item Nun	mber Mfr Item I	Mfr Item Name		Effective Date	Version	Manufacturing Site	Manufacturing Site		UOM	Unit Type		
]	FSA4485UC2	GA4485UCX USB Type-C Analo		th Protection	n 2024-05-20 CP2		CP2		4.2108	mg	Each		
Manufacturing Proccess Information													
Terminal Plating / Grid Array Material	Array Material Terminal Base Alloy		J-STD-020 MS	SL Rating	Peak Proc	ess Body Tem	perature Max Time at P	eak Tempera	ature Numb	er of Reflow Cyc	les		
SnAgCu CU Alloy 1			1		260	C	30	seco	onds 3				
Comments													
level 1 - maximum time at peak temperature du	uring solderi	ing is 10-30 seconds											
for more information regarding material comp	osition pleas	se refer to page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Backside Protection Film	0.2054	mg		Epoxy resin	proprietary data		0.043	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.0038	mg	
			Supplier	Acrylic resins	Proprietary Data		0.043	mg	
			Supplier	Silica (SiO2)	14464-46-1		0.1156	mg	
Die	2.37	mg	Supplier	Silicon (Si)	7440-21-3		2.37	mg	
Protection coat	0.049	mg		Polyimide	proprietary data		0.049	mg	
Solder Ball	1.521	mg	Supplier	Silver (Ag)	7440-22-4		0.0608	mg	
			Supplier	Tin (Sn)	7440-31-5		1.4526	mg	
			Supplier	Copper (Cu)	7440-50-8		0.0076	mg	
Under Bump Metal	0.0654	mg	Supplier	Titanium (Ti)	7440-32-6		0.0164	mg	
			Supplier	Copper (Cu)	7440-50-8		0.049	mg	